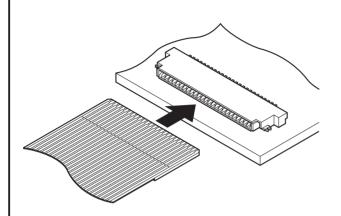


H CONNECTOR

0.5 mm pitch / Connectors for PC board / For FPC, Non-ZIF type



The large miniaturization at pitch direction and depth direction and low profile as 1.2 mm mounting height are realized. FH connector is miniaturized and space saving Non-ZIF type connector for FPC.

- Double-sided contact
- Applicable to standard FPC

Standards

Recognized E 60389

Specifications

• Current rating: 0.5 A AC/DC • Voltage rating: 50 V AC/DC • Temperature range: -25°C to +85°C

(including temperature rise in applying

electrical current)

Contact resistance: Initial value/40 mΩ max.

After environmental tests/20 m Ω max.

(variation from initial value)

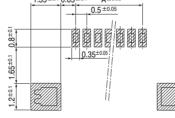
• Insulation resistance: 500 $M\Omega$ min. • Withstanding voltage: 200 V AC/minute • Applicable FPC: Conductor pitch/0.5 mm

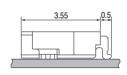
Conductor width/ 0.35 mm

Mating part thickness/ 0.3 ± 0.05 mm

- *In using the products, refer to "Handling Precaution for Terminals and Connectors" described on our website (Technical documents of Product information page).
- *RoHS2 compliance
- * Dimensional unit: mm
- * Contact JST for details.

PC board layout and Assembly layout



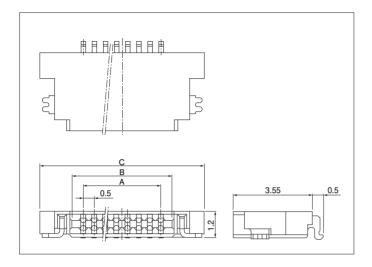


Note: 1. The above figure is the figure viewed from the connector mounting side.

2. Tolerances are non-cumulative: ± 0.08 mm for all centers.

Please contact JST for details as the dimensions shown in the above figure are reference values.

Connector



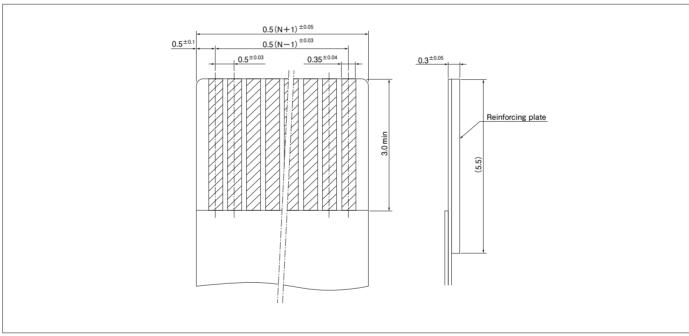
No. of circuits	Model No.	Dimensions (mm)			Q'ty/
		Α	В	С	reel
6	06FH-SM1-TB	2.5	3.5	6.4	4,000
10	10FH-SM1-TB	4.5	5.5	8.4	4,000
11	11FH-SM1-TB	5.0	6.0	8.9	4,000
14	14FH-SM1-TB	6.5	7.5	10.4	4,000
20	20FH-SM1-TB	9.5	10.5	13.4	4,000

Material and Finish

Contact : Copper alloy, copper-undercoated, tin-plated (reflow treatment) Housing : LCP, UL94V-0 Solder tab : Copper alloy, copper-undercoated, tin-plated (reflow treatment)

RoHS2 compliance This product displays (LF)(SN) on a label.

Dimensions of FPC lead section



Note: N --- Number of circuits